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1. Style

This specification describes "TACTILE SWITCH", mainly used as signal switch of electric devices, with the general requirements of mechanical and electrical characteristic.

1.1 Operating Temperature Range: -40°C+85°C 1.2 Storage Temperature Range : -40°C+85°C

2. Current Range: 50mA, 12 VDC3. Type of Actuation: Tactile feedback

4. Test Sequence:

| | ITEM | DESCRIPTION | TEST CONDITIONS | REQUIREMENTS |
|----------------------|------|---------------------------------------|--|---|
| APPEARANCE | 1 | Visual Examination | By visual examination check without any out pressure & testing. | There shall be no |
| | 2 | Contact Resistance | Applying a static load 1.5~2 times the operating force to the center made with a 1 kHz small current contact resistance meter. | 100mΩ Max. |
| ELECTRIC PERFORMANCE | 3 | Insulation Resistance | Measurements shall be made following application of 500 V DC potential across terminals and cover for 1 minute ±5 seconds. | 100MΩ Min. |
| | 4 | Dielectric Withstanding Voltage | 300 V AC(50Hz or 60Hz) shall be applied across terminals and cover for 1 minute | There shall be no breakdown or flashover. |
| | 5 | Capacitance | 1 MHz ±10kHz | 5 pF max. |
| | 6. | Bounce | 3 to 4 operations at a rate of 1 cycles per second Switch Switch Synchroscope 5V DC 5ΚΩ | 10 m seconds Max. |

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| MECHANICAL PERFORMANCE | 7. | Operating Force | Applied in the direction of operation. | | LTL-613R-V |
|------------------------|-----|---------------------------|---|---|--|
| | | | | OF | 200g+50g/-50g (2.04N+0.49N/-0.49N) |
| | 8. | Stroke | Placing the switch such that the direction of switch operation is vertical and then gradually increasing the load applied to the stem, the stroke distance for the stem to come to a stop shall be measured. | | 1.30+0.1/-0.3 mm |
| | 9. | Stop Strength | Placing the switch such that the direction of switch operation is vertical, a static load of 5 kgf(50N) shall be applied in the direction of stem operation for a period of 15 seconds | 2)Cor 200 3)Inst | shown in item 4~6 ntact Resistance: lmΩ Max ulation Resistance: lΩ Min |
| | 10. | Solder Heat Resistance | (PCB is 1.2 mm in thickness) ■SMT Type ~LTL-6-V Series(4/4) | 1)Shall be free from pronounced backlash and falling-off or breakage terminals 2)As shown in item 4~7 3)Contact Resistance: 200mΩ Max 4)Insulation Resistance: 10MΩ Min | |
| | 11. | Vibration | Shall be vibrated in accordance with Method 201A of MIL-STD-202F ①Frequency: 10-55-10Hz in 1-min/cycle. ②Direction: 3 vertical directions including the directions of operation ③Test time: 2 hours each direction. ④ Swing distance=1.5mm | 2)Coi 100 3)Ins | shown in item 4~7 ntact Resistance: Ω Max ulation Resistance: ΜΩ Min |

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| MECHANICAL PERFORMANCE | 12 | Shock | Shall be shocked in accordance with Method 213B condition A of MIL-STD-202F 1)Acceleration; 50G 2)Action time:11±1m seconds 3)Testing Direction: 6 sides 4)Test Cycle: 3 times in each direction | Ditto |
|---------------------------|----|-----------------------------------|--|--|
| DURABILITY | 13 | Operating | Measurements shall be made following the test forth below: 1)5 mA,5 VDC resistive load 2)Applying a static load the operating force to the center of the stem in the direction of operation 3)Cycle of Operation: 30, 000 cycles Min. For LTL-613R-V | 1)As shown in item 4~6 2)Operating force:±50% of initial force. 3)Contact Resistance: 10Ω Max 4)Insulation Resistance: 10ΜΩ Min 5)Bounce: 20 m seconds Max |
| WEATHER-PROOF | 15 | Resistance Low Temperature | Following the test set forth below the sample shall be left in normal temperature and humidity conditions for an hour before the measurements are made: 1)Temperature:-40±2°C 2)Time:500 hours | 1)As shown in item 4~7 2)Contact Resistance: 10Ω Max 3)Insulation Resistance: 10ΜΩ Min |
| | 16 | Resistance High Temperature | Following the test set forth below the sample shall be left in normal temperature and humidity conditions for an hour before the measurements are made: 1)Temperature:85±2°C 2)Time:500 hours | Ditto |
| | 17 | Resistance Humidity | Following the test set forth below the sample shall be left in normal temperature and humidity conditions for an hour before the measurements are made: 1)Temperature:60±2°C 2)Relative Humidity:90~95% 3)Time:500 hours | Ditto |

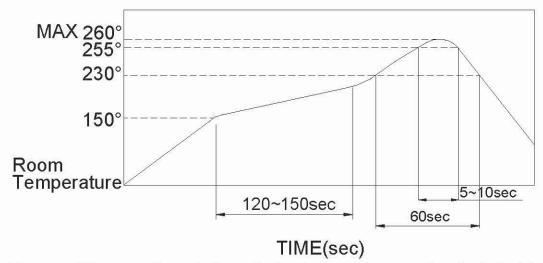
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5. SOLDERING CONDITIONS:

■ Condition for Reflow Soldering – S.M.T Series



■ The condition mentioned above is the temperature on the Cu foil of the PCB surface. There are cases where board's temperature greatly differs from switch's surface be used not to allow switch's surface temperature to exceed 260°C.

■ Manual Soldering

| Soldering Temperature | Max.350°C | |
|---------------------------|----------------|--|
| Continuous Soldering Time | Max. 5 seconds | |

Precautions in Handling

- 1. Care should be exercised so that flux from the upper part of the printed circuit board does not adhere to the switch.
- 2. Except for washable type do not wash the switch body.